



Advanced CMOS TTL Input – 54ACT02

Quad 2-input NOR gates with LSTTL compatible inputs in bare die form

Rev 1.0
18/05/21

Description

The 54ACT02 quad 2-input NOR gate is fabricated on a 1.5µm advanced CMOS process combining high speed LSTTL performance with CMOS low power. The device performs the Boolean function $Y = (A + B)$ or $Y = \bar{A} \cdot \bar{B}$ in positive logic. Internal circuitry comprises of three stages and includes buffered output for high noise immunity and stability. Inputs are directly compatible with LSTTL outputs. All inputs are protected against ESD and excess voltage transients.

Features:

- Inputs directly accept TTL
- Outputs directly interface CMOS, NMOS and TTL
- Outputs Source/Sink 24 mA
- Low Input Current: 1µA
- Functionally compatible with bipolar 54LS02
- Lower power alternative to bipolar logic
- Full Military Temperature Range

Ordering Information

The following part suffixes apply:

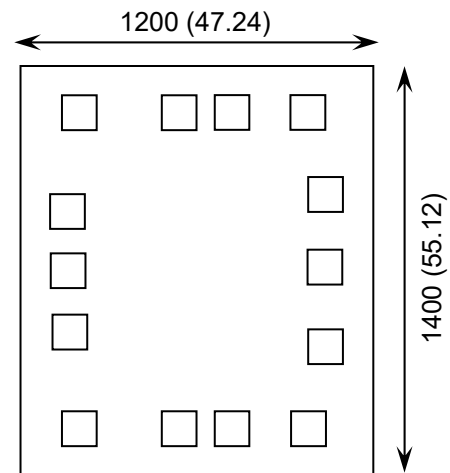
- No suffix - MIL-STD-883 /2010B Visual Inspection
- "H" - MIL-STD-883 /2010B Visual Inspection
+ MIL-PRF-38534 Class H LAT
- "K" - MIL-STD-883 /2010A Visual Inspection (Space)
+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com/quality/bare-die-lot-qualification

Die Dimensions in µm (mils)



Supply Formats:

- Default – Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape – On request
- Unsawn Wafer – On request
- Die Thickness <=> 350µm(14 Mils) – On request
- Assembled into Ceramic Package – On request

Mechanical Specification

| | | |
|------------------------|----------------------------|------------|
| Die Size (Unsawn) | 1200 x 1400 47 x 55 | µm mils |
| Minimum Bond Pad Size | 130 x 130 5.12 x 5.12 | µm mils |
| Die Thickness | 350 (±20) 13.78 (±0.79) | µm mils |
| Top Metal Composition | Al 1%Si 1.1µm | |
| Back Metal Composition | N/A – Bare Si | |

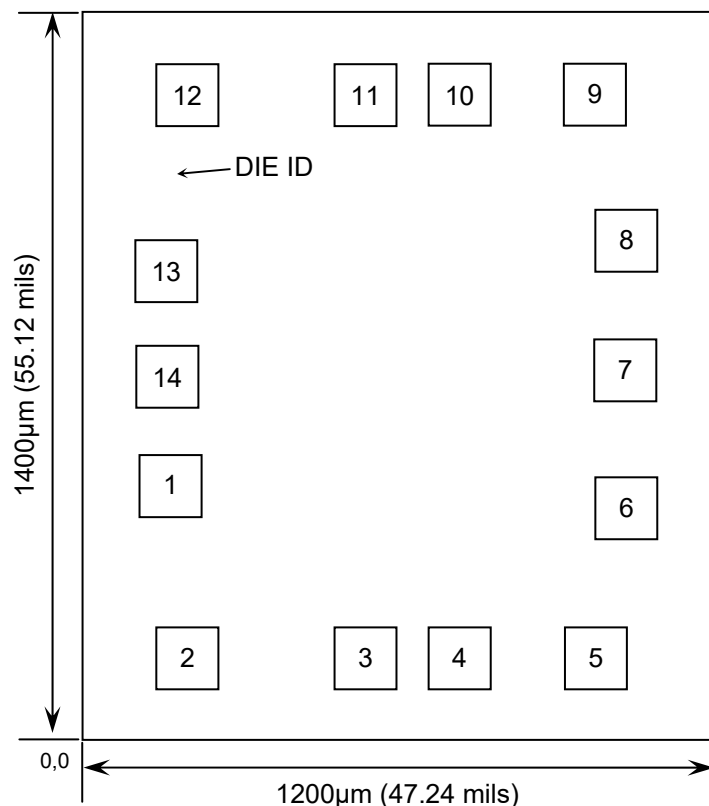




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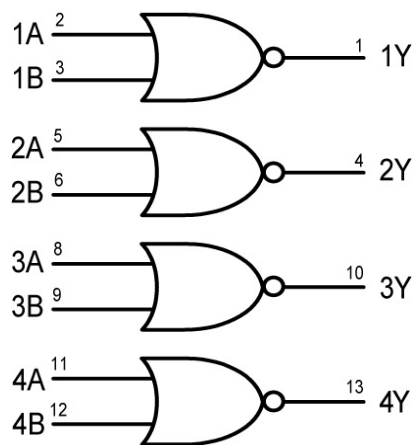
Pad Layout and Functions



| PAD | FUNCTION | COORDINATES (mm) | |
|-----|-----------------|------------------|-------|
| | | X | Y |
| 1 | 1Y | 0.100 | 0.430 |
| 2 | 1A | 0.140 | 0.100 |
| 3 | 1B | 0.480 | 0.100 |
| 4 | 2Y | 0.660 | 0.100 |
| 5 | 2A | 0.920 | 0.100 |
| 6 | 2B | 0.980 | 0.380 |
| 7 | GND | 0.980 | 0.650 |
| 8 | 3A | 0.980 | 0.900 |
| 9 | 3B | 0.920 | 1.180 |
| 10 | 3Y | 0.660 | 1.180 |
| 11 | 4A | 0.480 | 1.180 |
| 12 | 4B | 0.140 | 1.180 |
| 13 | 4Y | 0.100 | 0.840 |
| 14 | V _{CC} | 0.140 | 0.640 |

CONNECT CHIP BACK TO V_{CC} OR FLOAT

Logic Diagram



Pad 14 = V_{CC}
Pad 7 = GND

Truth Table

| INPUTS | | OUTPUT |
|--------|---|--------|
| A | B | Y |
| L | L | H |
| L | H | L |
| H | L | L |
| H | H | L |

H = High level (steady state)
L = Low level (steady state)





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Absolute Maximum Ratings¹

| PARAMETER | SYMBOL | VALUE | UNIT |
|---|-----------|------------------------|------|
| DC Supply Voltage (Referenced to GND) | V_{CC} | -0.5 to +7.0 | V |
| DC Input Voltage (Referenced to GND) | V_{IN} | -0.5 to $V_{CC} + 0.5$ | V |
| DC Output Voltage (Referenced to GND) | V_{OUT} | -0.5 to $V_{CC} + 0.5$ | V |
| DC Input Current | I_{IN} | ±20 | mA |
| DC Output Current, per pad | I_{OUT} | ±50 | mA |
| DC Supply Current, V_{CC} or GND, per pad | I_{CC} | ±50 | mA |
| Power Dissipation in Still Air ² | P_D | 750 | mW |
| Storage Temperature Range | T_{STG} | -65 to 150 | °C |

1. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability. 2. Measured in plastic DIP package, results in die form are dependent on die attach and assembly method.

Recommended Operating Conditions³ (Voltages Referenced to GND)

| PARAMETER | SYMBOL | MIN | MAX | UNITS | |
|--|-------------------|---------------------|----------|-------|------|
| DC Supply Voltage | V_{CC} | 4.5 | 5.5 | V | |
| DC Input or Output Voltage | V_{IN}, V_{OUT} | 0 | V_{CC} | V | |
| Operating Temperature Range | T_J | -55 | +125 | °C | |
| Output current - High | I_{OH} | - | -24 | mA | |
| Output current - Low | I_{OL} | - | 24 | mA | |
| Input Rise or Fall rate (V_{IN} from 0.8V to 2V) | $V_{CC} = 4.5V$ | $\Delta t/\Delta V$ | 0 | 10 | ns/V |
| | $V_{CC} = 5.5V$ | | 0 | 8 | |

3. This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC Electrical Characteristics (Voltages referenced to GND)

| PARAMETER | SYMBOL | V_{CC} | CONDITIONS | LIMITS | | | UNITS |
|----------------------------------|----------|----------|---|--------|------|-------------------------|-------|
| | | | | 25°C | 85°C | FULL RANGE ⁴ | |
| Minimum High-Level Input Voltage | V_{IH} | 4.5V | $V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$ | 2 | 2 | 2 | V |
| | | 5.5V | | 2 | 2 | 2 | |
| Maximum Low-Level Input Voltage | V_{IL} | 4.5V | $V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$ | 0.8 | 0.8 | 0.8 | V |
| | | 5.5V | | 0.8 | 0.8 | 0.8 | |
| Minimum Low-Level Output Voltage | V_{OL} | 4.5V | $I_{OUT} = 50\mu A$ | 0.1 | 0.1 | 0.1 | V |
| | | 5.5V | | 0.1 | 0.1 | 0.1 | |
| | | 4.5V | $V_{IN} = V_{IL} \text{ or } V_{IH}^5$ $I_{OL} = 24mA$ | 0.36 | 0.44 | 0.50 | V |
| | | 5.5V | | 0.36 | 0.44 | 0.50 | |
| | | 4.5V | $V_{IN} = V_{IL} \text{ or } V_{IH}^{5,6}$ $I_{OL} = 50mA$ | - | - | 1.65 | V |
| | | 5.5V | | - | - | 1.65 | |

4. $-55^\circ C \leq T_J \leq +125^\circ C$ 5. All outputs loaded; thresholds on input associated with output under test. 6. Test time 1sec max, measurement made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 75Ω transmission-line drive capability at 125°C





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DC Electrical Characteristics Continued (Voltages referenced to GND)

| PARAMETER | SYMBOL | V _{CC} | CONDITIONS | LIMITS | | | UNITS |
|---|--------------------|-----------------|--|--------|------|-------------------------|-------|
| | | | | 25°C | 85°C | FULL RANGE ⁴ | |
| Minimum High-Level Output Voltage | V _{OH} | 4.5V | I _{OUT} = 50µA | 4.4 | 4.4 | 4.4 | V |
| | | 5.5V | | 5.4 | 5.4 | 5.4 | |
| | | 4.5V | V _{IN} = V _{IL} or V _{IH} ⁵ I _{OH} = -24mA | 3.86 | 3.76 | 3.7 | V |
| | | 5.5V | | 4.86 | 4.76 | 4.7 | |
| Maximum Input Leakage Current | I _{IN} | 5.5V | V _{IN} = V _{CC} or GND | ±0.1 | ±1.0 | ±1.0 | µA |
| Additional Maximum I _{CC} / Input | ΔI _{CC} T | 5.5V | V _{IN} = V _{CC} -2.1V | 0.6 | 1.5 | 1.6 | mA |
| Minimum Dynamic Output Current ⁷ | I _{OLD} | 5.5V | V _{OLD} = 1.65V Max | - | 75 | 50 | mA |
| | I _{OHD} | 5.5V | V _{OHD} = 3.85V Min | - | -75 | -50 | |
| Maximum Quiescent Supply Leakage Current | I _{CC} | 5.5V | V _{IN} = V _{CC} or GND I _{OUT} = 0µA | 4 | 40 | 80 | µA |

7. Maximum test duration 2ms, one output loaded at a time.

AC Electrical Characteristics⁸ V_{CC} = 5.0V ±0.5V

| PARAMETER | SYMBOL | V _{CC} | CONDITIONS | LIMITS | | | UNITS |
|--|------------------|-----------------|--|---------|------|-------------------------|-------|
| | | | | 25°C | 85°C | FULL RANGE ⁴ | |
| Maximum Propagation Delay Input A to Output Y (Figure 1) | t _{PLH} | 5.0V | C _L = 50pF, Input tr = tf = 3.0ns | 8.5 | 9 | 12.2 | ns |
| | t _{PHL} | 5.0V | | 9.5 | 10 | 12.2 | |
| Maximum Input Capacitance | C _{IN} | 5.0V | T _J = 25°C | TYPICAL | | | pF |
| | | | | 4.5 | | | |
| Power Dissipation Capacitance | C _{PD} | 5.0V | T _J = 25°C, C _L = 50pF | 30 | | | pF |

8. Not production tested in die form, characterized by chip design





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Switching Waveform

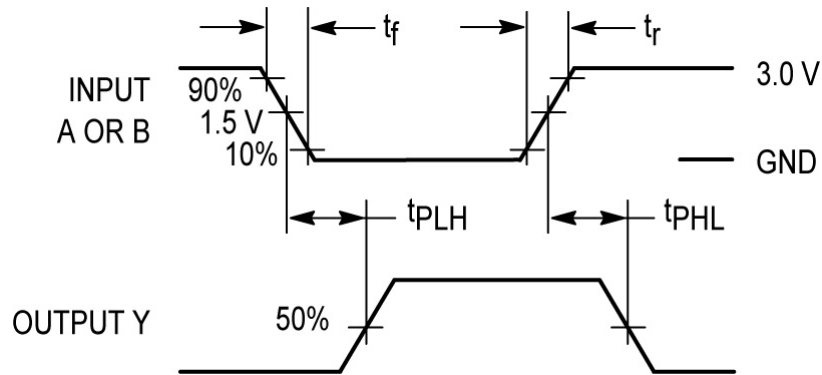
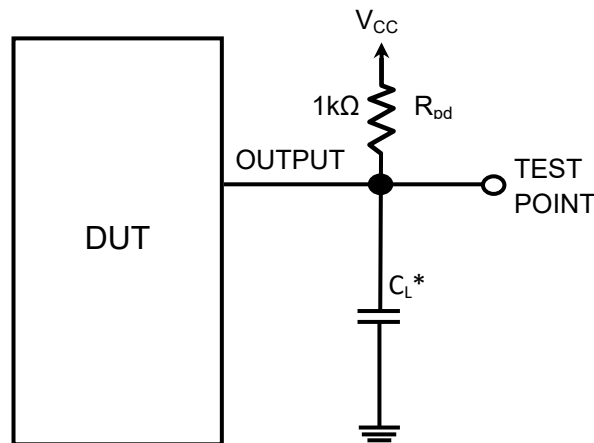


Figure 1 – Propagation delay, Input A or B to Output Y

Test Circuit



* Includes all probe and jig capacitance

Figure 2 - Test Circuit

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